MMCET 2025

2025 International Conference on Materials, Mechanical, and Civil Engineering Technologies Tokyo, Japan | December 17th-19th, 2025

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CALL FOR PAPERS

Important Dates

Submission Deadline - Full Paper September 30, 2025 Submission Deadline - Abstract September 30, 2025 Notification Date - Full Paper October 20, 2025 Notification Date - Abstract October 8, 2025 Registration Deadline November 10, 2025

Organizing Committee

- Conference Chairs Hisaki Watari, Tokyo Denki University Kazuo Umemura, Tokyo University of Science
- Program Chairs Yao Yan, UESTC John Chia-Yen Lee, National Pingtung University of Science and Technology Farid Abed, American University of Sharjah
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Contact

If you have any question, please feel free to contact our conference secretary:

E-mail: mmcet conf@163.com

About MMCET 2025

2025 International Conference on Materials, Mechanical, and Civil Engineering Technologies (MMCET 2025) will be held in Tokyo, Japan from December 17th-19th, 2025. MMCET 2025 is sponsored by Tokyo Denki University, University of Electronic Science and Technology of China, National Pingtung University of Science and Technology, American Society for Electrical Engineering and Universiti Teknologi Malaysia, and the aim of this conference is to bring together researchers and developers from both academia and industry to report on the latest scientific and theoretical advances, to discuss and debate major issues and to demonstrate state-of-the-art systems.

Conference Publication

Accepted full papers will be published in one of the following journals depending on the topic of your paper and submitted for SCI/SCOPUS/Ei Compendex index.













Submission

Full Paper Template:

https://mmcet.com/downloads/Paper%20Template% 20General.docx

Abstract Template:

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Submission Portal:

https://easychair.org/conferences/?conf=mmcet2025

and Biomedical Engineering Indexed in: ESCI, SCOPUS, EI (3) Key Engineering Materials Indexed in: SCOPUS, Inspec (4) Materials Science Forum

(2) Journal of Biomimetics, Biomaterials

Indexed in: SCOPUS, Inspec (5) Solid State Phenomena

(1) Journal of Nano Research

Indexed in: SCIE, SCOPUS, EI

Indexed in: SCOPUS, Inspec (6) Nano Hybrids and Composites Indexed in: ESCI, Inspec, CAS

(7) Advances in Science and Technology

Indexed in: SCOPUS

(8) Defect and Diffusion Forum

Indexed in: SCOPUS, EI

Special Issue

The journal **Discover Materials**, under the collection: Materials in Structural Engineering: Challenges and Innovations under Extreme Loading Conditions. Indexed in: DOAJ, ESCI and SCOPUS with an Impact Factor 5.1 (2024) and CiteScore 2024 of 3.6.



Topics of Interest

 Materials Engineering Nanomaterials Composite Materials Biomaterials Corrosion Resistance Additive Manufacturing Polymer Degradation Metal Fatigue **Smart Materials**

 Mechanical Engineering Thermodynamic Fluid Dynamics Dynamics of Machinery **Mechanical Vibrations** Heat Exchangers Renewable Energy Systems **CAD/CAM Technologies**

Gear Design and Analysis

Civil Engineering

Structural Engineering Geotechnical Analysis Transportation Planning Water Resource Management **Environmental Impact Assessment** Construction Techniques Pavement Engineering Seismic Design







